

## Low Power Triple and Quad Channels Digital Isolators

Check for Samples: [ISO7631FM](#), [ISO7631FC](#), [ISO7641FC](#)

### FEATURES

- Signaling Rate: 150 Mbps (M-Grade), 25 Mbps (C-Grade)
- Robust Design with Integrated Noise Filter (C-Grade)
- Low Power Consumption, Typical  $I_{CC}$  per Channel (3.3V Supplies):
  - ISO7631FM: 2 mA at 10 Mbps
  - ISO7631FC: 1.5 mA at 10 Mbps
  - ISO7641FC: 1.3 mA at 10 Mbps
- Extremely low  $I_{CC\_disable}$  (C-Grade)
- Low Propagation Delay: 7 ns Typical (M-Grade)
- Output Defaults to Low-state in Fail-safe Mode
- Wide Temperature Range:  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$
- 50 KV/ $\mu\text{s}$  Transient Immunity, Typical
- Long Life with  $\text{SiO}_2$  Isolation barrier
- Operates From 2.7V (M-Grade), 3.3 V and 5 V Supply and Logic Levels
- Wide Body SOIC-16 Package

### APPLICATIONS

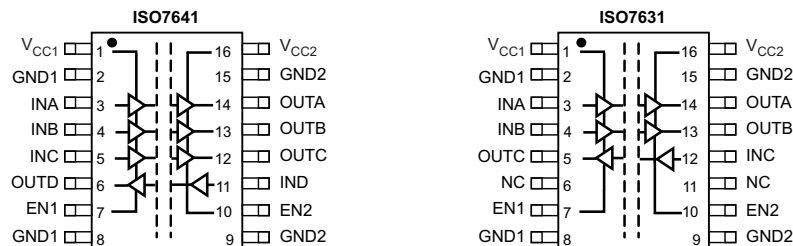
- Optocoupler Replacement in:
  - Industrial Fieldbus
  - Profibus
  - Modbus
  - DeviceNet™ Data Buses
- Servo Control Interface
- Motor Control
- Power Supplies
- Battery Packs

### SAFETY AND REGULATORY APPROVALS

- 2500  $V_{RMS}$  for 1 Minute per UL 1577 (approved)
- 4242  $V_{PK}$  VDE Rating for DIN EN 60747-5-2 (VDE 0884 Rev. 2), 1414  $V_{PK}$  Working Voltage (approved)
- CSA Component Acceptance Notice 5A (approved)
- 3000  $V_{RMS}$  Reinforced Insulation per TUV for EN/UL/CSA 60950-1 and EN/UL/CSA 61010-1 (approved)

### DESCRIPTION

ISO7631F and ISO7641F provide galvanic isolation up to 4242  $V_{PK}$  per VDE. ISO7631F has 3 channels with two in forward and one in reverse direction whereas ISO7641F has 4 channels with three in forward and one in reverse direction. Suffix F indicates that output defaults to Low-state in fail-safe conditions (see [Table 1](#)). M-Grade devices are high speed isolators capable of 150 Mbps data rate with fast propagation delays whereas C-Grade devices can run up to 25 Mbps data rate with low power consumption and integrated filters for noise-prone applications. C-Grade devices are recommended for lower speed applications where input noise pulses of less than 6 ns duration need to be suppressed or lower power consumption is critical.



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## DESCRIPTION CONTINUED

Each isolation channel has a logic input and output buffer separated by a silicon dioxide (SiO<sub>2</sub>) insulation barrier. Used in conjunction with isolated power supplies, these devices prevent noise currents on a data bus or other circuits from entering the local ground and interfering with or damaging sensitive circuitry. The devices have TTL input thresholds and can operate from 2.7 V (M-Grade), 3.3 V and 5 V supplies. All inputs are 5 V tolerant when supplied from 3.3 V or 2.7 V supplies.

### PIN DESCRIPTIONS

| PIN              |         |         | I/O | DESCRIPTION                                                                                                                                                                                           |
|------------------|---------|---------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME             | ISO7641 | ISO7631 |     |                                                                                                                                                                                                       |
| INA              | 3       | 3       | I   | Input, channel A                                                                                                                                                                                      |
| INB              | 4       | 4       | I   | Input, channel B                                                                                                                                                                                      |
| INC              | 5       | 12      | I   | Input, channel C                                                                                                                                                                                      |
| IND              | 11      | -       | I   | Input, channel D                                                                                                                                                                                      |
| OUTA             | 14      | 14      | O   | Output, channel A                                                                                                                                                                                     |
| OUTB             | 13      | 13      | O   | Output, channel B                                                                                                                                                                                     |
| OUTC             | 12      | 5       | O   | Output, channel C                                                                                                                                                                                     |
| OUTD             | 6       | -       | O   | Output, channel D                                                                                                                                                                                     |
| EN1              | 7       | 7       | I   | Enables (when input is High or Open) or Disables (when input is Low) OUTD of ISO7641 and OUTC of ISO7631                                                                                              |
| EN2              | 10      | 10      | I   | Enables (when input is High or Open) or Disables (when input is Low) OUTA, OUTB, and OUTC of ISO7641<br>Enables (when input is High or Open) or Disables (when input is Low) OUTA and OUTB of ISO7631 |
| V <sub>CC1</sub> | 1       | 1       | –   | Power supply, V <sub>CC1</sub>                                                                                                                                                                        |
| V <sub>CC2</sub> | 16      | 16      | –   | Power supply, V <sub>CC2</sub>                                                                                                                                                                        |
| GND1             | 2,8     | 2,8     | –   | Ground connection for V <sub>CC1</sub>                                                                                                                                                                |
| GND2             | 9,15    | 9,15    | –   | Ground connection for V <sub>CC2</sub>                                                                                                                                                                |
| NC               | -       | 6,11    | -   | No Connect pins are floating with no internal connection                                                                                                                                              |

**Table 1. FUNCTION TABLE<sup>(1)</sup>**

| INPUT<br>V <sub>CC</sub> | OUTPUT<br>V <sub>CC</sub> | INPUT<br>(IN <sub>x</sub> ) | OUTPUT ENABLE<br>(EN <sub>x</sub> ) | OUTPUT<br>(OUT <sub>x</sub> ) |
|--------------------------|---------------------------|-----------------------------|-------------------------------------|-------------------------------|
| PU                       | PU                        | H                           | H or Open                           | H                             |
|                          |                           | L                           | H or Open                           | L                             |
|                          |                           | X                           | L                                   | Z                             |
|                          |                           | Open                        | H or Open                           | L                             |
| PD                       | PU                        | X                           | H or Open                           | L                             |
| PD                       | PU                        | X                           | L                                   | Z                             |
| PU                       | PD                        | X                           | X                                   | Undetermined                  |

(1) PU = Powered Up (V<sub>CC</sub> ≥ 2.7 V); PD = Powered Down (V<sub>CC</sub> ≤ 2.1 V); X = Irrelevant; H = High Level; L = Low Level; Z = High Impedance

**AVAILABLE OPTIONS**

| PRODUCT   | RATED ISOLATION                                             | PACKAGE | INPUT THRESHOLD             | DATA RATE and FILTER             | CHANNEL DIRECTION    | MARKED AS | ORDERING NUMBER     |
|-----------|-------------------------------------------------------------|---------|-----------------------------|----------------------------------|----------------------|-----------|---------------------|
| ISO7631FM | 4242 V <sub>PK</sub> / 2500 V <sub>RMS</sub> <sup>(1)</sup> | DW-16   | 1.5 V TTL (CMOS Compatible) | 150 Mbps, No Noise Filter        | 2 Forward, 1 Reverse | ISO7631FM | ISO7631FMDW (rail)  |
|           |                                                             |         |                             |                                  |                      |           | ISO7631FMDWR (reel) |
| ISO7631FC |                                                             |         |                             | 25 Mbps, Integrated Noise Filter | 2 Forward, 1 Reverse | ISO7631FC | ISO7631FCDW (rail)  |
|           |                                                             |         |                             |                                  |                      |           | ISO7631FCDWR (reel) |
| ISO7641FC |                                                             |         |                             |                                  | 3 Forward, 1 Reverse | ISO7641FC | ISO7641FCDW (rail)  |
|           |                                                             |         |                             |                                  |                      |           | ISO7641FCDWR (reel) |

(1) See the [Regulatory Information](#) table for detailed isolation ratings.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

| PARAMETER                                    |                                     |                         |          | VALUE |      | UNIT |
|----------------------------------------------|-------------------------------------|-------------------------|----------|-------|------|------|
|                                              |                                     |                         |          | MIN   | MAX  |      |
| Supply voltage <sup>(2)</sup>                | V <sub>CC1</sub> , V <sub>CC2</sub> |                         |          | -0.5  | 6    | V    |
| Voltage                                      | INx, OUTx, ENx                      |                         |          | -0.5  | 6    | V    |
| Output Current, I <sub>O</sub>               |                                     |                         |          |       | ±15  | mA   |
| Electrostatic discharge                      | Human Body Model                    | ESDA, JEDEC JS-001-2012 | All pins |       | ±4   | kV   |
|                                              | Field-Induced Charged Device Model  | JEDEC JESD22-C101E      |          |       | ±1.5 | kV   |
|                                              | Machine Model                       | JEDEC JESD22-A115-A     |          |       | ±200 | V    |
| Maximum junction temperature, T <sub>J</sub> |                                     |                         |          |       | 150  | °C   |
| Storage temperature, T <sub>STG</sub>        |                                     |                         |          | -65   | 150  | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values except differential I/O bus voltages are with respect to the local ground terminal (GND1 or GND2) and are peak voltage values.

**RECOMMENDED OPERATING CONDITIONS**

| PARAMETER                 |                    |                        | MIN  | TYP | MAX      | UNIT |
|---------------------------|--------------------|------------------------|------|-----|----------|------|
| Supply voltage            | $V_{CC1}, V_{CC2}$ | M-Grade                | 2.7  |     | 5.5      | V    |
|                           |                    | C-Grade                | 3    |     | 5.5      |      |
| High-level output current | $I_{OH}$           |                        | -4   |     |          | mA   |
| Low-level output current  | $I_{OL}$           |                        |      |     | 4        | mA   |
| High-level input voltage  | $V_{IH}$           |                        | 2    |     | $V_{CC}$ | V    |
| Low-level input voltage   | $V_{IL}$           |                        | 0    |     | 0.8      | V    |
| Input pulse duration      | $t_{ui}$           | M-Grade: ≥3V-Operation | 6.67 |     |          | ns   |
|                           |                    | M-Grade: <3V-Operation | 10   |     |          |      |
|                           |                    | C-Grade: ≥3V-Operation | 40   |     |          |      |
| Signaling rate            | $1 / t_{ui}$       | M-Grade: ≥3V-Operation | 0    |     | 150      | Mbps |
|                           |                    | M-Grade: <3V-Operation | 0    |     | 100      |      |
|                           |                    | C-Grade: ≥3V-Operation | 0    |     | 25       |      |
| Junction temperature      | $T_J$              |                        | -40  |     | 136      | °C   |
| Ambient temperature       | $T_A$              |                        | -40  | 25  | 125      | °C   |

**THERMAL INFORMATION**

| THERMAL METRIC <sup>(1)</sup> |                                              |                                                                                                        | ISO76xx<br>DW (16 Pins) | UNITS |
|-------------------------------|----------------------------------------------|--------------------------------------------------------------------------------------------------------|-------------------------|-------|
|                               |                                              |                                                                                                        |                         |       |
| $\theta_{JA}$                 | Junction-to-ambient thermal resistance       |                                                                                                        | 72                      | °C/W  |
| $\theta_{JC(top)}$            | Junction-to-case(top) thermal resistance     |                                                                                                        | 38                      |       |
| $\theta_{JB}$                 | Junction-to-board thermal resistance         |                                                                                                        | 39                      |       |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   |                                                                                                        | 9.4                     |       |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter |                                                                                                        | n/a                     |       |
| $\theta_{JC(bottom)}$         | Junction-to-case(bottom) thermal resistance  |                                                                                                        | n/a                     |       |
| $P_D$                         | Maximum Device Power Dissipation             | $V_{CC1} = V_{CC2} = 5.5V, T_J = 150^\circ C, C_L = 15pF$<br>Input a 75 MHz 50% duty cycle square wave | 399                     | mW    |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## ELECTRICAL CHARACTERISTICS

$V_{CC1}$  and  $V_{CC2}$  at 5 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F                              |                                      | M-Grade               |     |     | C-Grade               |     |     | UNIT        |
|-------------------------------------------------|--------------------------------------|-----------------------|-----|-----|-----------------------|-----|-----|-------------|
| PARAMETER                                       | TEST CONDITIONS                      | MIN                   | TYP | MAX | MIN                   | TYP | MAX |             |
| $V_{OH}$ High-level output voltage              | $I_{OH} = -4$ mA; see Figure 1       | $V_{CCx}^{(1)} - 0.8$ | 4.8 |     | $V_{CCx}^{(1)} - 0.8$ | 4.7 |     | V           |
|                                                 | $I_{OH} = -20$ $\mu$ A; see Figure 1 | $V_{CCx}^{(1)} - 0.1$ | 5   |     | $V_{CCx}^{(1)} - 0.1$ | 5   |     |             |
| $V_{OL}$ Low-level output voltage               | $I_{OL} = 4$ mA; see Figure 1        |                       | 0.2 | 0.4 |                       | 0.3 | 0.5 | V           |
|                                                 | $I_{OL} = 20$ $\mu$ A; see Figure 1  |                       | 0   | 0.1 |                       | 0   | 0.1 |             |
| $V_{I(HYS)}$ Input threshold voltage hysteresis |                                      |                       | 450 |     |                       | 450 |     | mV          |
| $I_{IH}$ High-level input current               | $V_{IH} = V_{CC}$ at INx or ENx      |                       |     | 10  |                       |     | 10  | $\mu$ A     |
| $I_{IL}$ Low-level input current                | $V_{IL} = 0$ V at INx or ENx         | -10                   |     |     | -10                   |     |     |             |
| CMTI Common-mode transient immunity             | $V_I = V_{CC}$ or 0 V; see Figure 4  | 25                    | 75  |     | 25                    | 75  |     | kV/ $\mu$ s |

(1)  $V_{CCx}$  is the supply voltage,  $V_{CC1}$  or  $V_{CC2}$ , for the output channel that is being measured.

## SWITCHING CHARACTERISTICS

$V_{CC1}$  and  $V_{CC2}$  at 5 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F                                                 |                             | M-Grade |     |      | C-Grade |                      |     | UNIT    |
|--------------------------------------------------------------------|-----------------------------|---------|-----|------|---------|----------------------|-----|---------|
| PARAMETER                                                          | TEST CONDITIONS             | MIN     | TYP | MAX  | MIN     | TYP                  | MAX |         |
| $t_{PLH}$ , $t_{PHL}$ Propagation delay time                       | See Figure 1                | 3.5     | 7   | 10.5 | 11      | 17                   | 28  | ns      |
| PWD <sup>(1)</sup> Pulse width distortion [ $t_{PHL} - t_{PLH}$ ]  |                             |         |     | 2    |         |                      | 3   |         |
| $t_{sk(o)}$ <sup>(2)</sup> Channel-to-channel output skew time     | Same-direction Channels     |         |     | 2    |         |                      | 3   | ns      |
|                                                                    | Opposite-direction Channels |         |     | 3    |         |                      | 4   |         |
| $t_{sk(pp)}$ <sup>(3)</sup> Part-to-part skew time                 |                             |         |     | 4.5  |         |                      | 13  |         |
| $t_r$ Output signal rise time                                      | See Figure 1                |         | 1.6 |      |         | 2.8                  |     | ns      |
| $t_f$ Output signal fall time                                      |                             |         | 1   |      |         | 2.9                  |     |         |
| $t_{PHZ}$ Disable Propagation Delay, high-to-high impedance output | See Figure 2                |         | 5   | 16   |         | 8                    | 20  | ns      |
| $t_{PLZ}$ Disable Propagation Delay, low-to-high impedance output  |                             |         | 5   | 16   |         | 7                    | 20  |         |
| $t_{PZH}$ Enable Propagation Delay, high impedance-to-high output  |                             |         | 4   | 16   | 11000   | 22000 <sup>(4)</sup> |     |         |
| $t_{PZL}$ Enable Propagation Delay, high impedance-to-low output   |                             |         | 4   | 16   |         | 8                    | 20  |         |
| $t_{fs}$ Fail-safe output delay time from input data or power loss | See Figure 3                |         | 9.5 |      |         | 9                    |     | $\mu$ s |

(1) Also known as Pulse Skew.

(2)  $t_{sk(o)}$  is the skew between outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical loads.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.

(4) The enable signal rate for C-grade devices should be  $\leq$  45 Kbps.

**SUPPLY CURRENT**
 $V_{CC1}$  and  $V_{CC2}$  at 5 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F         |                 |                                                                                                                                               | M-Grade         |     |      | C-Grade        |     |     |      |    |
|------------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|----------------|-----|-----|------|----|
| PARAMETER        | TEST CONDITIONS |                                                                                                                                               | MIN             | TYP | MAX  | MIN            | TYP | MAX | UNIT |    |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                               | 2.5             |     | 4    | 1.1            |     | 1.9 | mA   |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               | 3.7             |     | 5.4  | 1.5            |     | 2.6 |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF  | 2.6             |     | 4.1  | 1.8            |     | 2.7 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               | 3.8             |     | 5.5  | 2.6            |     | 3.9 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               | 3.3             |     | 4.5  | 2.7            |     | 3.7 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               | 4.9             |     | 6.6  | 3.9            |     | 5.3 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               | 4.5             |     | 6    | 4.1            |     | 5.4 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               | 6.8             |     | 9    | 5.9            |     | 7.8 |      |    |
| I <sub>CC1</sub> | 150 Mbps        |                                                                                                                                               | 15              |     | 19.5 | Not Applicable |     |     |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               | 22              |     | 30   |                |     |     |      |    |
| ISO7641F         |                 |                                                                                                                                               |                 |     |      | C-Grade        |     |     |      |    |
| I <sub>CC1</sub> | Disable         |                                                                                                                                               | EN1 = EN2 = 0 V |     |      |                | 1.2 |     | 2.1  | mA |
| I <sub>CC2</sub> |                 | 1.6                                                                                                                                           |                 |     |      |                | 2.6 |     |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V,<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF |                 |     |      | 1.8            |     | 2.8 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      | 3.1            |     | 4.2 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |                 |     |      | 3              |     | 4   |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      | 4.9            |     | 6.1 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |                 |     |      | 4.8            |     | 6   |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      | 7.7            |     | 9.5 |      |    |

## ELECTRICAL CHARACTERISTICS

 $V_{CC1}$  at 5 V  $\pm$  10% and  $V_{CC2}$  at 3.3 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F                              |                                                      | M-Grade                       |                 |     | C-Grade         |     |     | UNIT        |
|-------------------------------------------------|------------------------------------------------------|-------------------------------|-----------------|-----|-----------------|-----|-----|-------------|
| PARAMETER                                       | TEST CONDITIONS                                      | MIN                           | TYP             | MAX | MIN             | TYP | MAX |             |
| $V_{OH}$ High-level output voltage              | $I_{OH} = -4$ mA; see <a href="#">Figure 1</a>       | OUTx on $V_{CC1}$ (5V) side   | $V_{CC1} - 0.8$ | 4.8 | $V_{CC1} - 0.8$ | 4.7 |     | V           |
|                                                 |                                                      | OUTx on $V_{CC2}$ (3.3V) side | $V_{CC2} - 0.4$ | 3   | $V_{CC2} - 0.6$ | 2.9 |     |             |
|                                                 | $I_{OH} = -20$ $\mu$ A; see <a href="#">Figure 1</a> | OUTx on $V_{CC1}$ (5V) side   | $V_{CC1} - 0.1$ | 5   | $V_{CC1} - 0.1$ | 5   |     |             |
|                                                 |                                                      | OUTx on $V_{CC2}$ (3.3V) side | $V_{CC2} - 0.1$ | 3.3 | $V_{CC2} - 0.1$ | 3.3 |     |             |
| $V_{OL}$ Low-level output voltage               | $I_{OL} = 4$ mA; see <a href="#">Figure 1</a>        |                               | 0.2             | 0.4 |                 | 0.3 | 0.5 | V           |
|                                                 | $I_{OL} = 20$ $\mu$ A; see <a href="#">Figure 1</a>  |                               | 0               | 0.1 |                 | 0   | 0.1 |             |
| $V_{I(HYS)}$ Input threshold voltage hysteresis |                                                      |                               | 430             |     |                 | 430 |     | mV          |
| $I_{IH}$ High-level input current               | $V_{IH} = V_{CC}$ at INx or ENx                      |                               |                 | 10  |                 |     | 10  | $\mu$ A     |
| $I_{IL}$ Low-level input current                | $V_{IL} = 0$ V at INx or ENx                         | -10                           |                 |     | -10             |     |     |             |
| CMTI Common-mode transient immunity             | $V_I = V_{CC}$ or 0 V; see <a href="#">Figure 4</a>  | 25                            | 50              |     | 25              | 50  |     | kV/ $\mu$ s |

## SWITCHING CHARACTERISTICS

 $V_{CC1}$  at 5 V  $\pm$  10% and  $V_{CC2}$  at 3.3 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F                                                 |                              | M-Grade |     |     | C-Grade |       |                      | UNIT    |
|--------------------------------------------------------------------|------------------------------|---------|-----|-----|---------|-------|----------------------|---------|
| PARAMETER                                                          | TEST CONDITIONS              | MIN     | TYP | MAX | MIN     | TYP   | MAX                  |         |
| $t_{PLH}$ , $t_{PHL}$ Propagation delay time                       | See <a href="#">Figure 1</a> | 4       | 8   | 13  | 11      | 18    | 32                   | ns      |
| PWD <sup>(1)</sup> Pulse width distortion $ t_{PHL} - t_{PLH} $    |                              |         |     | 2   |         |       | 3.5                  |         |
| $t_{sk(o)}$ <sup>(2)</sup> Channel-to-channel output skew time     | Same-direction Channels      |         |     | 2.5 |         |       | 4.5                  |         |
|                                                                    | Opposite-direction Channels  |         |     | 3.5 |         |       | 5.5                  |         |
| $t_{sk(pp)}$ <sup>(3)</sup> Part-to-part skew time                 |                              |         |     | 6   |         |       | 15                   |         |
| $t_r$ Output signal rise time                                      | See <a href="#">Figure 1</a> |         | 2   |     |         | 3.6   |                      | ns      |
| $t_f$ Output signal fall time                                      |                              |         | 1.2 |     |         | 3.3   |                      |         |
| $t_{PHZ}$ Disable Propagation Delay, high-to-high impedance output | See <a href="#">Figure 2</a> |         | 6.5 | 17  |         | 9     | 20                   | ns      |
| $t_{PLZ}$ Disable Propagation Delay, low-to-high impedance output  |                              |         | 6.5 | 17  |         | 8     | 20                   |         |
| $t_{PZH}$ Enable Propagation Delay, high impedance-to-high output  |                              |         | 5.5 | 17  |         | 11000 | 22000 <sup>(4)</sup> |         |
| $t_{PZL}$ Enable Propagation Delay, high impedance-to-low output   |                              |         | 5.5 | 17  |         | 10    | 30                   |         |
| $t_{fs}$ Fail-safe output delay time from input data or power loss | See <a href="#">Figure 3</a> |         | 9.5 |     |         | 8.5   |                      | $\mu$ s |

(1) Also known as Pulse Skew.

(2)  $t_{sk(o)}$  is the skew between outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical loads.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.

(4) The enable signal rate for C-grade devices should be  $\leq$  45 Kbps.

## SUPPLY CURRENT

$V_{CC1}$  at  $5\text{ V} \pm 10\%$  and  $V_{CC2}$  at  $3.3\text{ V} \pm 10\%$  (over recommended operating conditions unless otherwise noted)

| ISO7631F         |                 |                                                                                                                                               | M-Grade         |      |      | C-Grade        |     |     |      |    |
|------------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----------------|------|------|----------------|-----|-----|------|----|
| PARAMETER        | TEST CONDITIONS |                                                                                                                                               | MIN             | TYP  | MAX  | MIN            | TYP | MAX | UNIT |    |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                               |                 | 2.5  | 4    |                | 1.1 | 1.9 | mA   |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 2.7  | 3.7  |                | 0.7 | 1.3 |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF  |                 | 2.6  | 4.1  |                | 1.8 | 2.7 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 2.8  | 3.8  |                | 1.8 | 2.6 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |                 | 3.3  | 4.5  |                | 2.7 | 3.7 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 3.5  | 4.6  |                | 2.6 | 3.5 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |                 | 4.5  | 6    |                | 4.1 | 5.4 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 4.7  | 5.9  |                | 3.8 | 5   |      |    |
| I <sub>CC1</sub> | 150 Mbps        |                                                                                                                                               |                 | 15   | 19.5 | Not Applicable |     |     |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 14.6 | 19   |                |     |     |      |    |
| ISO7641F         |                 |                                                                                                                                               |                 |      |      | C-Grade        |     |     |      |    |
| I <sub>CC1</sub> | Disable         |                                                                                                                                               | EN1 = EN2 = 0 V |      |      |                |     | 1.2 | 2.1  | mA |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |      |      |                | 0.8 | 1.3 |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V,<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF |                 |      |      |                | 1.8 | 2.8 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |      |      |                | 2   | 2.9 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |                 |      |      |                | 3   | 4   |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |      |      |                | 3.2 | 4.1 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |                 |      |      |                | 4.8 | 6   |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |      |      |                | 5.1 | 7   |      |    |

## ELECTRICAL CHARACTERISTICS

 $V_{CC1}$  at  $3.3V \pm 10\%$  and  $V_{CC2}$  at  $5V \pm 10\%$  (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F |                                    |                                                                  |                                | M-Grade       |     |     | C-Grade       |     |     | UNIT              |
|--------------------|------------------------------------|------------------------------------------------------------------|--------------------------------|---------------|-----|-----|---------------|-----|-----|-------------------|
| PARAMETER          |                                    | TEST CONDITIONS                                                  |                                | MIN           | TYP | MAX | MIN           | TYP | MAX |                   |
| $V_{OH}$           | High-level output voltage          | $I_{OH} = -4\text{ mA}$ ; see <a href="#">Figure 1</a>           | OUTx on $V_{CC1}$ (3.3 V) side | $V_{CC1}-0.4$ | 3   |     | $V_{CC1}-0.6$ | 2.9 |     | V                 |
|                    |                                    |                                                                  | OUTx on $V_{CC2}$ (5 V) side   | $V_{CC2}-0.8$ | 4.8 |     | $V_{CC2}-0.8$ | 4.7 |     |                   |
|                    |                                    | $I_{OH} = -20\text{ }\mu\text{A}$ ; see <a href="#">Figure 1</a> | OUTx on $V_{CC1}$ (3.3 V) side | $V_{CC1}-0.1$ | 3.3 |     | $V_{CC1}-0.1$ | 3.3 |     |                   |
|                    |                                    |                                                                  | OUTx on $V_{CC2}$ (5 V) side   | $V_{CC2}-0.1$ | 5   |     | $V_{CC2}-0.1$ | 5   |     |                   |
| $V_{OL}$           | Low-level output voltage           | $I_{OL} = 4\text{ mA}$ ; see <a href="#">Figure 1</a>            |                                |               | 0.2 | 0.4 |               | 0.3 | 0.5 | V                 |
|                    |                                    | $I_{OL} = 20\text{ }\mu\text{A}$ ; see <a href="#">Figure 1</a>  |                                |               | 0   | 0.1 |               | 0   | 0.1 |                   |
| $V_{I(HYS)}$       | Input threshold voltage hysteresis |                                                                  |                                |               | 430 |     |               | 430 |     | mV                |
| $I_{IH}$           | High-level input current           | $V_{IH} = V_{CC}$ at INx or ENx                                  |                                |               |     | 10  |               |     | 10  | $\mu\text{A}$     |
| $I_{IL}$           | Low-level input current            | $V_{IL} = 0\text{ V}$ at INx or ENx                              |                                |               | -10 |     |               | -10 |     |                   |
| CMTI               | Common-mode transient immunity     | $V_I = V_{CC}$ or $0\text{ V}$ ; see <a href="#">Figure 4</a>    |                                |               | 25  | 50  |               | 25  | 50  | kV/ $\mu\text{s}$ |

## SWITCHING CHARACTERISTICS

 $V_{CC1}$  at  $3.3\text{ V} \pm 10\%$  and  $V_{CC2}$  at  $5\text{ V} \pm 10\%$  (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F          |                                                           |                              |  | M-Grade |     |      | C-Grade |       |                      | UNIT          |
|-----------------------------|-----------------------------------------------------------|------------------------------|--|---------|-----|------|---------|-------|----------------------|---------------|
| PARAMETER                   |                                                           | TEST CONDITIONS              |  | MIN     | TYP | MAX  | MIN     | TYP   | MAX                  |               |
| $t_{PLH}, t_{PHL}$          | Propagation delay time                                    | See <a href="#">Figure 1</a> |  | 4       | 7.5 | 12.5 | 11      | 18.5  | 32                   | ns            |
| PWD <sup>(1)</sup>          | Pulse width distortion $ t_{PHL} - t_{PLH} $              |                              |  |         |     | 2    |         |       | 2.5                  |               |
| $t_{sk(o)}$ <sup>(2)</sup>  | Channel-to-channel output skew time                       | Same-direction Channels      |  |         |     | 2.5  |         |       | 4.5                  |               |
|                             |                                                           | Opposite-direction Channels  |  |         |     | 3.5  |         |       | 5.5                  |               |
| $t_{sk(pp)}$ <sup>(3)</sup> | Part-to-part skew time                                    |                              |  |         |     | 6    |         |       | 15                   |               |
| $t_r$                       | Output signal rise time                                   | See <a href="#">Figure 1</a> |  |         | 1.7 |      |         | 2.9   |                      | ns            |
| $t_f$                       | Output signal fall time                                   |                              |  |         | 1.1 |      |         | 2.9   |                      |               |
| $t_{PHZ}$                   | Disable Propagation Delay, high-to-high impedance output  | See <a href="#">Figure 2</a> |  |         | 5.5 | 17   |         | 8     | 20                   | ns            |
| $t_{PLZ}$                   | Disable Propagation Delay, low-to-high impedance output   |                              |  |         | 5.5 | 17   |         | 7     | 20                   |               |
| $t_{PZH}$                   | Enable Propagation Delay, high impedance-to-high output   |                              |  |         | 4.5 | 17   |         | 11000 | 22000 <sup>(4)</sup> |               |
| $t_{PZL}$                   | Enable Propagation Delay, high impedance-to-low output    |                              |  |         | 4.5 | 17   |         | 8     | 30                   |               |
| $t_{fs}$                    | Fail-safe output delay time from input data or power loss | See <a href="#">Figure 3</a> |  |         | 9.5 |      |         | 7.5   |                      | $\mu\text{s}$ |

(1) Also known as Pulse Skew.

(2)  $t_{sk(o)}$  is the skew between outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical loads.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.

(4) The enable signal rate for C-grade devices should be  $\leq 45\text{ Kbps}$ .

**SUPPLY CURRENT**
 $V_{CC1}$  at  $3.3V \pm 10\%$  and  $V_{CC2}$  at  $5V \pm 10\%$  (over recommended operating conditions unless otherwise noted)

| ISO7631F         |                 |                                                                                                                                               | M-Grade         |     |      | C-Grade        |     |     |      |    |
|------------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-----|------|----------------|-----|-----|------|----|
| PARAMETER        | TEST CONDITIONS |                                                                                                                                               | MIN             | TYP | MAX  | MIN            | TYP | MAX | UNIT |    |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                               |                 | 1.8 | 2.8  |                | 0.6 | 1.1 | mA   |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 3.7 | 5.4  |                | 1.5 | 2.6 |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF  |                 | 1.9 | 2.9  |                | 1.2 | 1.8 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 3.8 | 5.5  |                | 2.6 | 3.9 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |                 | 2.4 | 3.4  |                | 1.8 | 2.6 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 4.9 | 6.6  |                | 3.9 | 5.3 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |                 | 3.2 | 4.2  |                | 2.7 | 3.6 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 6.8 | 9    |                | 5.9 | 7.8 |      |    |
| I <sub>CC1</sub> | 150 Mbps        |                                                                                                                                               |                 | 9.3 | 12.5 | Not Applicable |     |     |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 | 22  | 30   |                |     |     |      |    |
| ISO7641F         |                 |                                                                                                                                               |                 |     |      | C-Grade        |     |     |      |    |
| I <sub>CC1</sub> | Disable         |                                                                                                                                               | EN1 = EN2 = 0 V |     |      |                |     | 0.7 | 1.1  | mA |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      | 1.6            | 2.6 |     |      |    |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V,<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF |                 |     |      |                | 1.2 | 1.9 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      |                | 3.1 | 4.2 |      |    |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |                 |     |      |                | 2   | 2.8 |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      |                | 4.9 | 6.1 |      |    |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |                 |     |      |                | 3.1 | 4   |      |    |
| I <sub>CC2</sub> |                 |                                                                                                                                               |                 |     |      |                | 7.7 | 9.5 |      |    |

## ELECTRICAL CHARACTERISTICS

 $V_{CC1}$  and  $V_{CC2}$  at 3.3 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F  |                                    |                                                                       | M-Grade                               |     |     | C-Grade                               |     |     |       |
|---------------------|------------------------------------|-----------------------------------------------------------------------|---------------------------------------|-----|-----|---------------------------------------|-----|-----|-------|
| PARAMETER           |                                    | TEST CONDITIONS                                                       | MIN                                   | TYP | MAX | MIN                                   | TYP | MAX | UNIT  |
| V <sub>OH</sub>     | High-level output voltage          | I <sub>OH</sub> = −4 mA; see <a href="#">Figure 1</a>                 | V <sub>CCx</sub> <sup>(1)</sup> − 0.4 | 3   |     | V <sub>CCx</sub> <sup>(1)</sup> − 0.6 | 2.9 |     | V     |
|                     |                                    | I <sub>OH</sub> = −20 μA; see <a href="#">Figure 1</a>                | V <sub>CCx</sub> <sup>(1)</sup> − 0.1 | 3.3 |     | V <sub>CCx</sub> <sup>(1)</sup> − 0.1 | 3.3 |     |       |
| V <sub>OL</sub>     | Low-level output voltage           | I <sub>OL</sub> = 4 mA; see <a href="#">Figure 1</a>                  |                                       | 0.2 | 0.4 |                                       | 0.3 | 0.5 | V     |
|                     |                                    | I <sub>OL</sub> = 20 μA; see <a href="#">Figure 1</a>                 |                                       | 0   | 0.1 |                                       | 0   | 0.1 |       |
| V <sub>I(HYS)</sub> | Input threshold voltage hysteresis |                                                                       |                                       | 425 |     |                                       | 425 |     | mV    |
| I <sub>IH</sub>     | High-level input current           | V <sub>IH</sub> = V <sub>CC</sub> at INx or ENx                       |                                       |     | 10  |                                       |     | 10  | μA    |
| I <sub>IL</sub>     | Low-level input current            | V <sub>IL</sub> = 0 V at INx or ENx                                   | −10                                   |     |     | −10                                   |     |     |       |
| CMTI                | Common-mode transient immunity     | V <sub>I</sub> = V <sub>CC</sub> or 0 V; see <a href="#">Figure 4</a> | 25                                    | 50  |     | 25                                    | 50  |     | kV/μs |

(1)  $V_{CCx}$  is the supply voltage,  $V_{CC1}$  or  $V_{CC2}$ , for the output channel that is being measured.

## SWITCHING CHARACTERISTICS

 $V_{CC1}$  and  $V_{CC2}$  at 3.3 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F, ISO7641F                  |                                                             |                             | M-Grade |     |     | C-Grade |       |                      |      |
|-------------------------------------|-------------------------------------------------------------|-----------------------------|---------|-----|-----|---------|-------|----------------------|------|
| PARAMETER                           |                                                             | TEST CONDITIONS             | MIN     | TYP | MAX | MIN     | TYP   | MAX                  | UNIT |
| t <sub>PLH</sub> , t <sub>PHL</sub> | Propagation delay time                                      | See Figure 1                | 4       | 8.5 | 14  | 12      | 23    | 35                   | ns   |
| PWD <sup>(1)</sup>                  | Pulse width distortion  t <sub>PHL</sub> – t <sub>PLH</sub> |                             |         |     | 2   |         |       | 3                    |      |
| t <sub>sk(o)</sub> <sup>(2)</sup>   | Channel-to-channel output skew time                         | Same-direction Channels     |         |     | 3   |         |       | 5                    |      |
|                                     |                                                             | Opposite-direction Channels |         |     | 4   |         |       | 6                    |      |
| t <sub>sk(pp)</sub> <sup>(3)</sup>  | Part-to-part skew time                                      |                             |         |     | 6.5 |         |       | 16                   |      |
| t <sub>r</sub>                      | Output signal rise time                                     | See Figure 1                |         |     | 2   |         |       | 3.7                  | ns   |
| t <sub>f</sub>                      | Output signal fall time                                     |                             |         |     | 1.3 |         |       | 3.4                  |      |
| t <sub>PHZ</sub>                    | Disable Propagation Delay, high-to-high impedance output    | See Figure 2                |         |     | 6.5 | 17      | 9     | 20                   | ns   |
| t <sub>PLZ</sub>                    | Disable Propagation Delay, low-to-high impedance output     |                             |         |     | 6.5 | 17      | 8     | 20                   |      |
| t <sub>PZH</sub>                    | Enable Propagation Delay, high impedance-to-high output     |                             |         |     | 5.5 | 17      | 11000 | 22000 <sup>(4)</sup> |      |
| t <sub>PZL</sub>                    | Enable Propagation Delay, high impedance-to-low output      |                             |         |     | 5.5 | 17      | 10    | 30                   |      |
| t <sub>fs</sub>                     | Fail-safe output delay time from input data or power loss   | See Figure 3                |         |     | 9.2 |         | 7.5   |                      | μs   |

(1) Also known as Pulse Skew.

(2)  $t_{sk(o)}$  is the skew between outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical loads.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.

(4) The enable signal rate for C-grade devices should be  $\leq 45$  Kbps.

## SUPPLY CURRENT

$V_{CC1}$  and  $V_{CC2}$  at 3.3 V  $\pm$  10% (over recommended operating conditions unless otherwise noted)

| ISO7631F         |                 |                                                                                                                                               | M-Grade |      |      | C-Grade        |     |     |      |
|------------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------|---------|------|------|----------------|-----|-----|------|
| PARAMETER        | TEST CONDITIONS |                                                                                                                                               | MIN     | TYP  | MAX  | MIN            | TYP | MAX | UNIT |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                               |         | 1.8  | 2.8  |                | 0.6 | 1.1 | mA   |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         | 2.7  | 3.7  |                | 0.7 | 1.3 |      |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF  |         | 1.9  | 2.9  |                | 1.2 | 1.8 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         | 2.8  | 3.8  |                | 1.8 | 2.6 |      |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |         | 2.4  | 3.4  |                | 1.8 | 2.6 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         | 3.5  | 4.6  |                | 2.6 | 3.5 |      |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |         | 3.2  | 4.2  |                | 2.7 | 3.6 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         | 4.7  | 5.9  |                | 3.8 | 5   |      |
| I <sub>CC1</sub> | 150 Mbps        |                                                                                                                                               |         | 9.3  | 12.5 | Not Applicable |     |     |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         | 14.6 | 19   |                |     |     |      |
| ISO7641F         |                 |                                                                                                                                               |         |      |      | C-Grade        |     |     |      |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                               |         |      |      |                | 0.7 | 1.1 | mA   |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         |      |      |                | 0.8 | 1.3 |      |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V,<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF |         |      |      |                | 1.2 | 1.9 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         |      |      |                | 2   | 2.9 |      |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                               |         |      |      |                | 2   | 2.8 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         |      |      |                | 3.2 | 4.1 |      |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                               |         |      |      |                | 3.1 | 4   |      |
| I <sub>CC2</sub> |                 |                                                                                                                                               |         |      |      |                | 5.1 | 7   |      |

## ELECTRICAL CHARACTERISTICS

$V_{CC1}$  and  $V_{CC2}$  at 2.7 V<sup>(1)</sup> (over recommended operating conditions unless otherwise noted)

| ISO7631F            |                                    |                                                                       | M-Grade                              |     |     |       |
|---------------------|------------------------------------|-----------------------------------------------------------------------|--------------------------------------|-----|-----|-------|
| PARAMETER           |                                    | TEST CONDITIONS                                                       | MIN                                  | TYP | MAX | UNIT  |
| V <sub>OH</sub>     | High-level output voltage          | I <sub>OH</sub> = −4 mA; see <a href="#">Figure 1</a>                 | V <sub>CC</sub> <sup>(2)</sup> − 0.5 | 2.4 |     | V     |
|                     |                                    | I <sub>OH</sub> = −20 μA; see <a href="#">Figure 1</a>                | V <sub>CC</sub> <sup>(2)</sup> − 0.1 | 2.7 |     |       |
| V <sub>OL</sub>     | Low-level output voltage           | I <sub>OL</sub> = 4 mA; see <a href="#">Figure 1</a>                  |                                      | 0.2 | 0.4 | V     |
|                     |                                    | I <sub>OL</sub> = 20 μA; see <a href="#">Figure 1</a>                 |                                      | 0   | 0.1 |       |
| V <sub>I(HYS)</sub> | Input threshold voltage hysteresis |                                                                       |                                      | 350 |     | mV    |
| I <sub>IH</sub>     | High-level input current           | V <sub>IH</sub> = V <sub>CC</sub> at INx or ENx                       |                                      |     | 10  | μA    |
| I <sub>IL</sub>     | Low-level input current            | V <sub>IL</sub> = 0 V at INx or ENx                                   | -10                                  |     |     |       |
| CMTI                | Common-mode transient immunity     | V <sub>I</sub> = V <sub>CC</sub> or 0 V; see <a href="#">Figure 4</a> | 25                                   | 50  |     | kV/μs |

(1) Only M-Grade devices are recommended for operation down to 2.7 V supplies. For 2.7 V-operation, max data rate is 100 Mbps.

(2)  $V_{CCx}$  is the supply voltage,  $V_{CC1}$  or  $V_{CC2}$ , for the output channel that is being measured.

## SWITCHING CHARACTERISTICS

$V_{CC1}$  and  $V_{CC2}$  at 2.7 V (over recommended operating conditions unless otherwise noted)

| ISO7631F                            |                                                             |                             | M-Grade |     |     |      |
|-------------------------------------|-------------------------------------------------------------|-----------------------------|---------|-----|-----|------|
| PARAMETER                           |                                                             | TEST CONDITIONS             | MIN     | TYP | MAX | UNIT |
| t <sub>PLH</sub> , t <sub>PHL</sub> | Propagation delay time                                      | See Figure 1                | 5       | 8   | 16  | ns   |
| PWD <sup>(1)</sup>                  | Pulse width distortion  t <sub>PHL</sub> – t <sub>PLH</sub> |                             |         |     | 2.5 |      |
| t <sub>sk(o)</sub> <sup>(2)</sup>   | Channel-to-channel output skew time                         | Same-direction Channels     |         |     | 4   |      |
|                                     |                                                             | Opposite-direction Channels |         |     | 5   |      |
| t <sub>sk(pp)</sub> <sup>(3)</sup>  | Part-to-part skew time                                      |                             |         |     | 8   |      |
| t <sub>r</sub>                      | Output signal rise time                                     | See Figure 1                |         | 2.3 |     | ns   |
| t <sub>f</sub>                      | Output signal fall time                                     |                             |         | 1.8 |     |      |
| t <sub>PHZ</sub>                    | Disable Propagation Delay, high-to-high impedance output    | See Figure 2                |         | 8   | 18  | ns   |
| t <sub>PLZ</sub>                    | Disable Propagation Delay, low-to-high impedance output     |                             |         | 8   | 18  |      |
| t <sub>PZH</sub>                    | Enable Propagation Delay, high impedance-to-high output     |                             |         | 7   | 18  |      |
| t <sub>PZL</sub>                    | Enable Propagation Delay, high impedance-to-low output      |                             |         | 7   | 18  |      |
| t <sub>fs</sub>                     | Fail-safe output delay time from input data or power loss   | See Figure 3                |         | 8.5 |     | μs   |

(1) Also known as Pulse Skew.

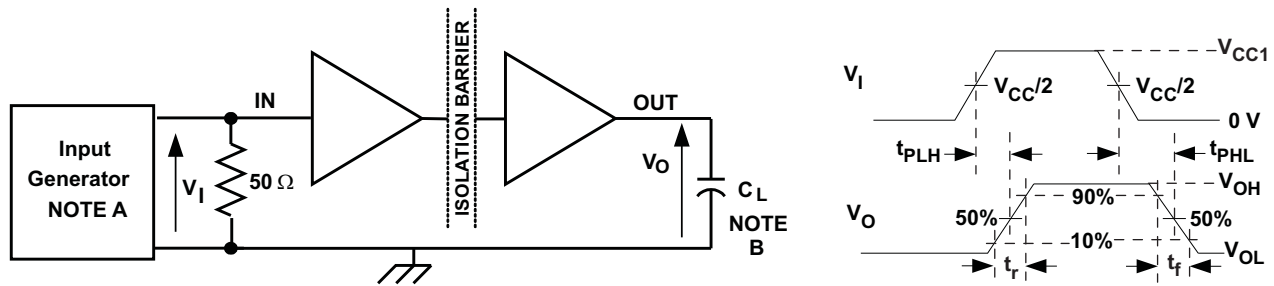
(2)  $t_{sk(o)}$  is the skew between outputs of a single device with all driving inputs connected together and the outputs switching in the same direction while driving identical loads.

(3)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any terminals of different devices switching in the same direction while operating at identical supply voltages, temperature, input signals and loads.

**SUPPLY CURRENT**
 $V_{CC1}$  and  $V_{CC2}$  at 2.7 V (over recommended operating conditions unless otherwise noted)

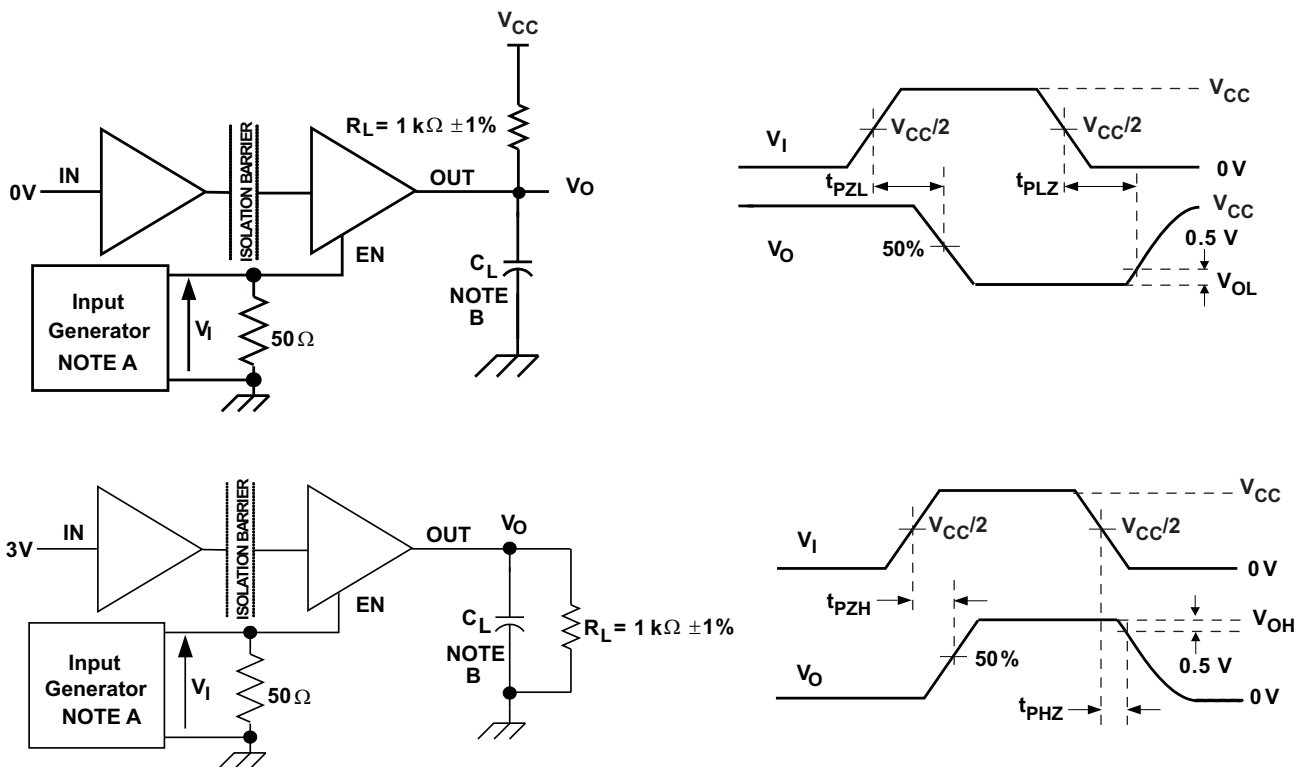
| ISO7631F         |                 |                                                                                                                                              | M-Grade |     |     |      |
|------------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------|---------|-----|-----|------|
| PARAMETER        | TEST CONDITIONS |                                                                                                                                              | MIN     | TYP | MAX | UNIT |
| I <sub>CC1</sub> | Disable         | EN1 = EN2 = 0 V                                                                                                                              | 1.5     |     | 2.4 | mA   |
| I <sub>CC2</sub> |                 |                                                                                                                                              | 2.2     |     | 3.2 |      |
| I <sub>CC1</sub> | DC to 1 Mbps    | DC Signal: V <sub>I</sub> = V <sub>CC</sub> or 0 V<br>AC Signal: All channels switching with square wave clock input; C <sub>L</sub> = 15 pF | 1.6     |     | 2.5 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                              | 2.3     |     | 3.2 |      |
| I <sub>CC1</sub> | 10 Mbps         |                                                                                                                                              | 2       |     | 2.9 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                              | 3       |     | 3.9 |      |
| I <sub>CC1</sub> | 25 Mbps         |                                                                                                                                              | 2.7     |     | 3.7 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                              | 3.9     |     | 4.9 |      |
| I <sub>CC1</sub> | 100 Mbps        |                                                                                                                                              | 5.7     |     | 6.8 |      |
| I <sub>CC2</sub> |                 |                                                                                                                                              | 8.6     |     | 12  |      |

## PARAMETER MEASUREMENT INFORMATION



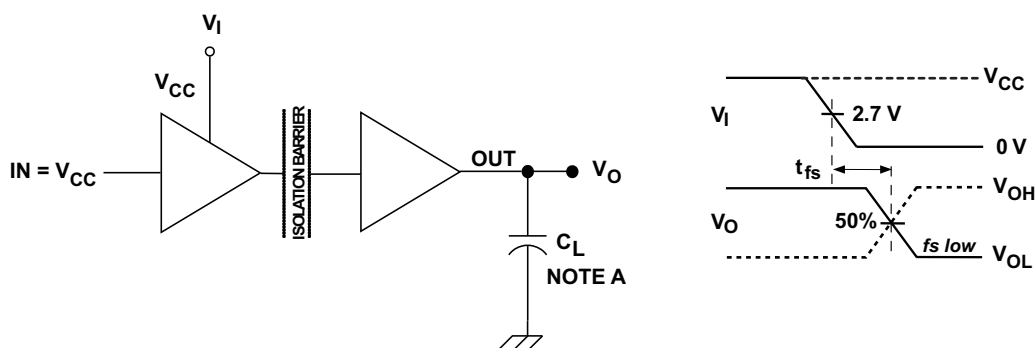
- The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  50 kHz, 50% duty cycle,  $t_r \leq$  3 ns,  $t_f \leq$  3 ns,  $Z_O = 50 \Omega$ . At the input,  $50 \Omega$  resistor is required to terminate Input Generator signal. It is not needed in actual application.
- $C_L = 15$  pF and includes instrumentation and fixture capacitance within  $\pm 20\%$ .

Figure 1. Switching Characteristics Test Circuit and Voltage Waveforms

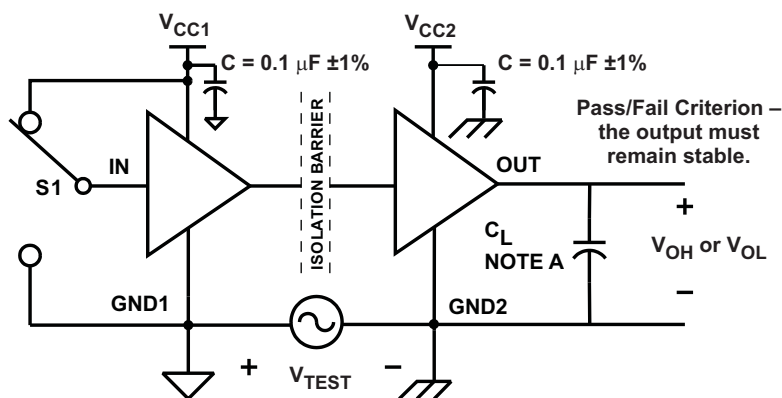


- The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  10 kHz, 50% duty cycle,  $t_r \leq$  3 ns,  $t_f \leq$  3 ns,  $Z_O = 50 \Omega$ .
- $C_L = 15$  pF and includes instrumentation and fixture capacitance within  $\pm 20\%$ .

Figure 2. Enable/Disable Propagation Delay Time Test Circuit and Waveform

**PARAMETER MEASUREMENT INFORMATION (continued)**

A.  $C_L = 15 \text{ pF}$  and includes instrumentation and fixture capacitance within  $\pm 20\%$ .

**Figure 3. Failsafe Delay Time Test Circuit and Voltage Waveforms**

A.  $C_L = 15 \text{ pF}$  and includes instrumentation and fixture capacitance within  $\pm 20\%$ .

**Figure 4. Common-Mode Transient Immunity Test Circuit**

## DEVICE INFORMATION

### IEC INSULATION AND SAFETY-RELATED SPECIFICATIONS FOR DW-16 PACKAGE

| PARAMETER                      |                                                  | TEST CONDITIONS                                                                       | MIN   | TYP               | MAX | UNIT |
|--------------------------------|--------------------------------------------------|---------------------------------------------------------------------------------------|-------|-------------------|-----|------|
| L(I01)                         | Minimum air gap (Clearance)                      | Shortest terminal to terminal distance through air                                    | 8.3   |                   |     | mm   |
| L(I02) <sup>(1)</sup>          | Minimum external tracking (Creepage)             | Shortest terminal to terminal distance across the package surface                     | 8.1   |                   |     | mm   |
| CTI                            | Tracking resistance (Comparative Tracking Index) | DIN IEC 60112 / VDE 0303 Part 1                                                       | ≥400  |                   |     | V    |
|                                | Minimum Internal Gap (Internal Clearance)        | Distance through the insulation                                                       | 0.014 |                   |     | mm   |
| R <sub>IO</sub> <sup>(2)</sup> | Isolation resistance, Input to Output            | V <sub>IO</sub> = 500 V, T <sub>A</sub> < 100°C                                       |       | >10 <sup>12</sup> |     | Ω    |
|                                |                                                  | V <sub>IO</sub> = 500 V, 100°C ≤ T <sub>A</sub> ≤ max                                 |       | >10 <sup>11</sup> |     |      |
| C <sub>IO</sub> <sup>(2)</sup> | Barrier capacitance, Input to Output             | V <sub>I</sub> = 0.4 sin (2πft), f = 1MHz                                             |       | 2                 |     | pF   |
| C <sub>I</sub> <sup>(3)</sup>  | Input capacitance                                | V <sub>I</sub> = V <sub>CC</sub> /2 + 0.4 sin (2πft), f = 1MHz, V <sub>CC</sub> = 5 V |       | 2                 |     | pF   |

(1) Per JEDEC package dimensions.

(2) All pins on each side of the barrier tied together creating a two-terminal device.

(3) Measured from input pin to ground.

#### NOTE

Creepage and clearance requirements should be applied according to the specific equipment isolation standards of an application. Care should be taken to maintain the creepage and clearance distance of a board design to ensure that the mounting pads of the isolator on the printed circuit board do not reduce this distance.

Creepage and clearance on a printed circuit board become equal according to the measurement techniques shown in the Isolation Glossary. Techniques such as inserting grooves and/or ribs on a printed circuit board are used to help increase these specifications.

**Table 2. DIN EN 60747-5-2 (VDE 0884 TEIL 2) INSULATION CHARACTERISTICS<sup>(1)</sup>  
over recommended operating conditions (unless otherwise noted)**

| PARAMETER         |                                    | TEST CONDITIONS                                                                                                                     | SPECIFICATION    | UNIT              |
|-------------------|------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|------------------|-------------------|
| V <sub>IORM</sub> | Maximum working insulation voltage |                                                                                                                                     | 1414             | V <sub>PEAK</sub> |
| V <sub>PR</sub>   | Input-to-output test voltage       | After Input/Output safety test subgroup 2/3,<br>V <sub>PR</sub> = V <sub>IORM</sub> × 1.2, t = 10 s,<br>Partial discharge < 5 pC    | 1697             | V <sub>PEAK</sub> |
|                   |                                    | Method a, After environmental tests subgroup 1,<br>V <sub>PR</sub> = V <sub>IORM</sub> × 1.6, t = 10 s,<br>Partial Discharge < 5 pC | 2262             |                   |
|                   |                                    | Method b1, 100% Production test<br>V <sub>PR</sub> = V <sub>IORM</sub> × 1.875, t = 1 s<br>Partial discharge < 5 pC                 | 2652             |                   |
| V <sub>IOTM</sub> | Maximum transient overvoltage      | V <sub>TEST</sub> = V <sub>IOTM</sub><br>t = 60 sec (Qualification)<br>t = 1 sec (100% Production)                                  | 4242             | V <sub>PEAK</sub> |
| R <sub>S</sub>    | Insulation resistance              | V <sub>IO</sub> = 500 V at T <sub>S</sub>                                                                                           | >10 <sup>9</sup> | Ω                 |
|                   | Pollution degree                   |                                                                                                                                     | 2                |                   |

(1) Climatic Classification 40/125/21

**Table 3. IEC 60664-1 RATINGS TABLE**

| PARAMETER                   | TEST CONDITIONS                         | SPECIFICATION |
|-----------------------------|-----------------------------------------|---------------|
| Basic Isolation Group       | Material Group                          | II            |
| Installation classification | Rated mains voltage $\leq 300 V_{RMS}$  | I–IV          |
|                             | Rated mains voltage $\leq 600 V_{RMS}$  | I–III         |
|                             | Rated mains voltage $\leq 1000 V_{RMS}$ | I–II          |

**REGULATORY INFORMATION**

| VDE                                                                                                        | TUV                                                                                                                                                   | CSA                                                | UL                                                  |
|------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------|-----------------------------------------------------|
| Certified according to DIN EN 60747-5-2                                                                    | Certified according to EN/UL/CSA 60950-1 and 61010-1                                                                                                  | Approved under CSA Component Acceptance Notice #5A | Recognized under 1577 Component Recognition Program |
| Basic Insulation<br>Maximum Transient Overvoltage, 4242 $V_{PK}$<br>Maximum Working Voltage, 1414 $V_{PK}$ | 3000 $V_{RMS}$ Reinforced Insulation, 400 $V_{RMS}$ maximum working voltage<br>3000 $V_{RMS}$ Basic Insulation, 600 $V_{RMS}$ maximum working voltage | 4242 $V_{PK}$ Insulation                           | Single Protection, 2500 $V_{RMS}$ <sup>(1)</sup>    |
| File Number: 40016131                                                                                      | Certificate Number: U8V 13 09 77311 010                                                                                                               | File Number: 220991                                | File Number: E181974                                |

(1) Production tested  $\geq 3000 V_{RMS}$  for 1 second in accordance with UL 1577.

**IEC SAFETY LIMITING VALUES**

Safety limiting intends to prevent potential damage to the isolation barrier upon failure of input or output circuitry. A failure of the IO can allow low resistance to ground or the supply and, without current limiting, dissipate sufficient power to overheat the die and damage the isolation barrier potentially leading to secondary system failures.

| PARAMETER                                     | TEST CONDITIONS |                                                                                                                 |  | MIN | TYP | MAX | UNIT             |
|-----------------------------------------------|-----------------|-----------------------------------------------------------------------------------------------------------------|--|-----|-----|-----|------------------|
| $I_S$ Safety input, output, or supply current | DW-16           | $\theta_{JA} = 72^\circ\text{C/W}$ , $V_I = 5.5\text{V}$ , $T_J = 150^\circ\text{C}$ , $T_A = 25^\circ\text{C}$ |  |     |     | 316 | mA               |
|                                               |                 | $\theta_{JA} = 72^\circ\text{C/W}$ , $V_I = 3.6\text{V}$ , $T_J = 150^\circ\text{C}$ , $T_A = 25^\circ\text{C}$ |  |     |     | 482 |                  |
|                                               |                 | $\theta_{JA} = 72^\circ\text{C/W}$ , $V_I = 2.7\text{V}$ , $T_J = 150^\circ\text{C}$ , $T_A = 25^\circ\text{C}$ |  |     |     | 643 |                  |
| $T_S$ Maximum case temperature                |                 |                                                                                                                 |  |     |     | 150 | $^\circ\text{C}$ |

The safety-limiting constraint is the absolute maximum junction temperature specified in the absolute maximum ratings table. The power dissipation and junction-to-air thermal impedance of the device installed in the application hardware determines the junction temperature. The assumed junction-to-air thermal resistance in the *Thermal Information* table is that of a device installed on a High-K Test Board for Leaded Surface Mount Packages. The power is the recommended maximum input voltage times the current. The junction temperature is then the ambient temperature plus the power times the junction-to-air thermal resistance.

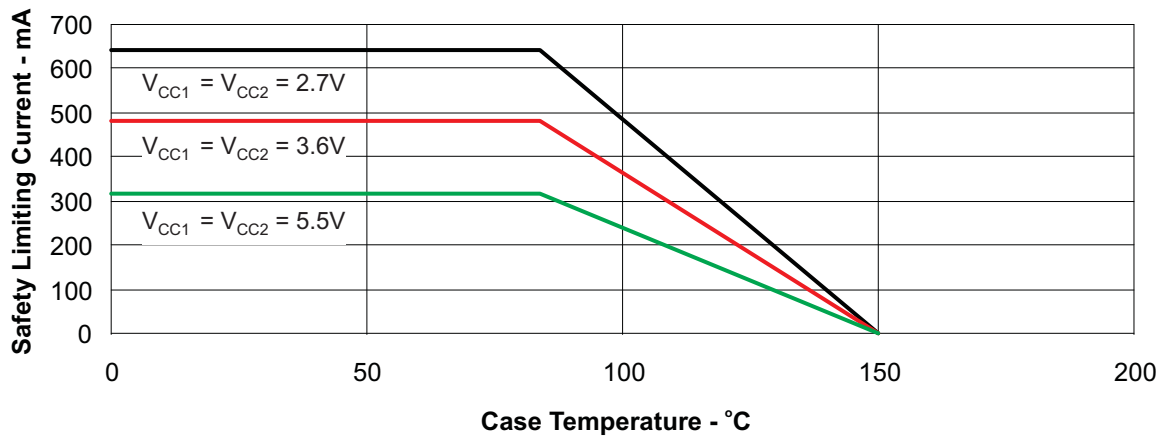


Figure 5. DW-16  $\theta_{JC}$  Thermal Derating Curve per IEC 60747-5-2

### APPLICATION INFORMATION

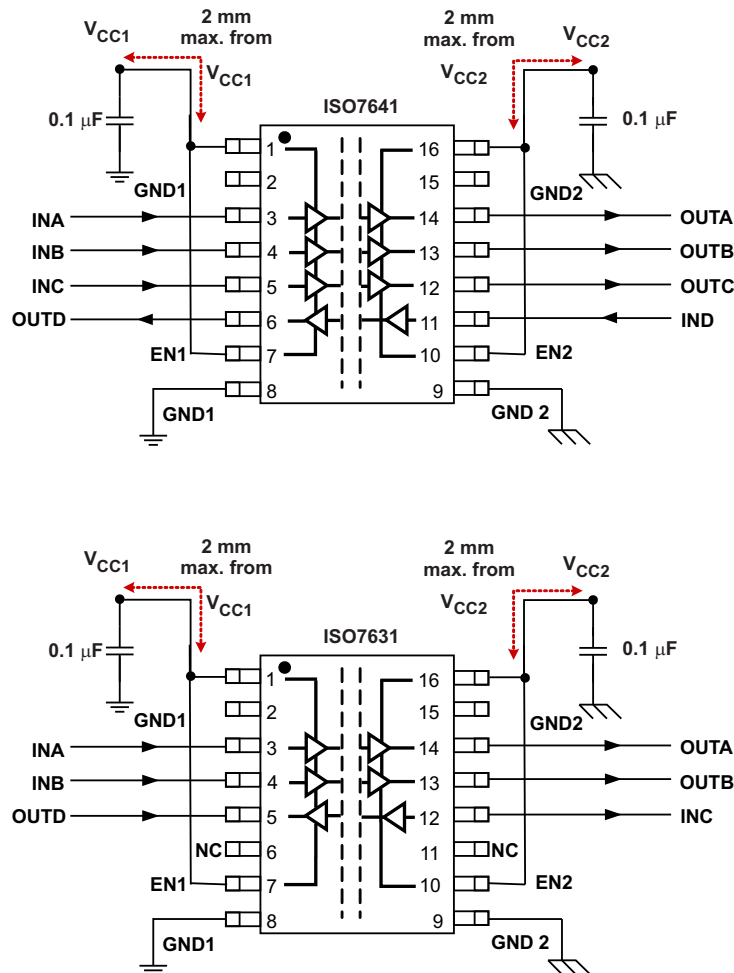


Figure 6. Typical ISO7641 and ISO7631 Application Circuit

Note: For detailed layout recommendations, see Application Note [SLLA284](#), *Digital Isolator Design Guide*.

## TYPICAL SUPPLY CURRENT EQUATIONS

(Calculated based on room temperature and typical Silicon process)

### ISO7631FM:

At  $V_{CC1} = V_{CC2} = 3.3V$

$$I_{CC1} = 1.8072 + 0.0244 \times f + 0.0016 \times f \times C_L$$

$$I_{CC2} = 2.4625 + 0.0252 \times f + 0.0033 \times f \times C_L$$

At  $V_{CC1} = V_{CC2} = 5V$

$$I_{CC1} = 2.3183 + 0.04 \times f + 0.0025 \times f \times C_L$$

$$I_{CC2} = 3.2582 + 0.0403 \times f + 0.0049 \times f \times C_L$$

### ISO7631FC:

At  $V_{CC1} = V_{CC2} = 3.3V$

$$I_{CC1} = 1.1762 + 0.0325 \times f + 0.0017 \times f \times C_L$$

$$I_{CC2} = 1.5285 + 0.0299 \times f + 0.0033 \times f \times C_L$$

At  $V_{CC1} = V_{CC2} = 5V$

$$I_{CC1} = 1.6001 + 0.0528 \times f + 0.0025 \times f \times C_L$$

$$I_{CC2} = 2.2032 + 0.0475 \times f + 0.005 \times f \times C_L$$

### ISO7641FC:

At  $V_{CC1} = V_{CC2} = 3.3V$

$$I_{CC1} = 1.2162 + 0.0462 \times f + 0.0017 \times f \times C_L$$

$$I_{CC2} = 1.8054 + 0.0411 \times f + 0.005 \times f \times C_L$$

At  $V_{CC1} = V_{CC2} = 5V$

$$I_{CC1} = 1.6583 + 0.0757 \times f + 0.0025 \times f \times C_L$$

$$I_{CC2} = 2.5008 + 0.0655 \times f + 0.0076 \times f \times C_L$$

$I_{CC1}$  and  $I_{CC2}$  are typical supply currents measured in mA;  $f$  is data rate measured in Mbps;  $C_L$  is the capacitive load on each channel measured in pF.

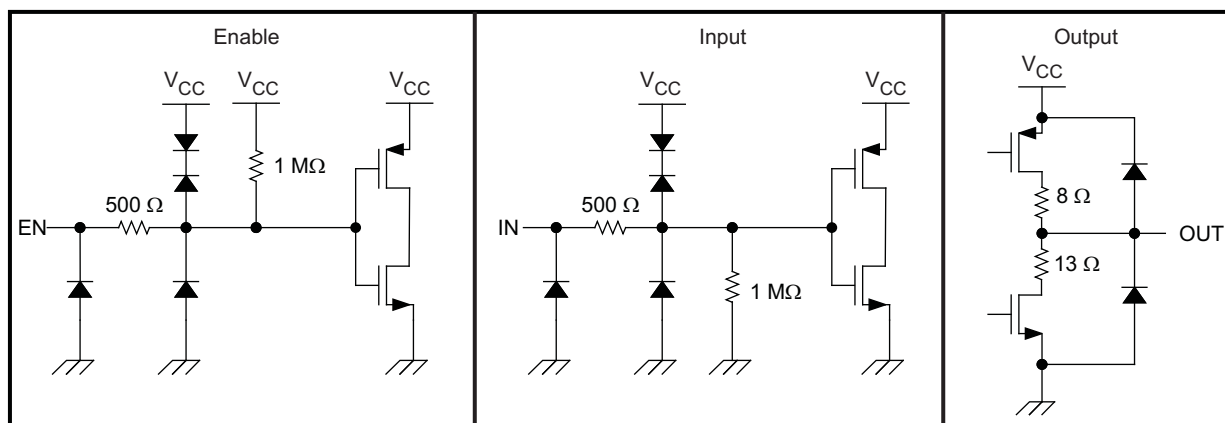
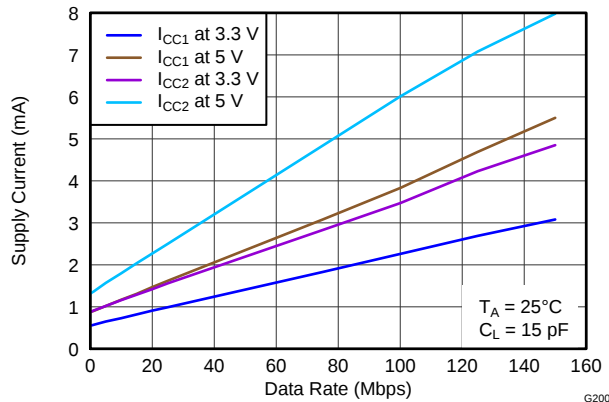
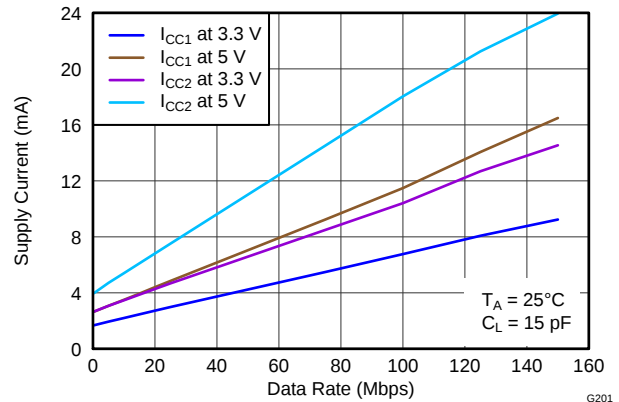


Figure 7. Device I/O Schematics

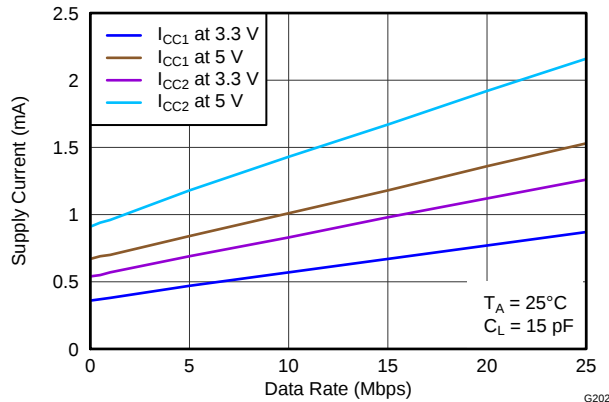
## TYPICAL CHARACTERISTICS



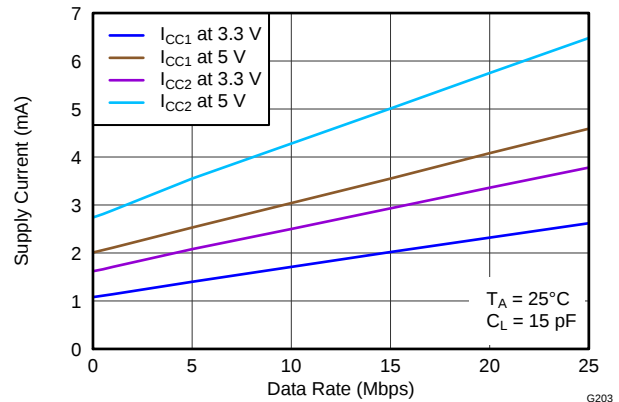
**Figure 8. ISO7631FM Supply Current Per Channel vs Data Rate**



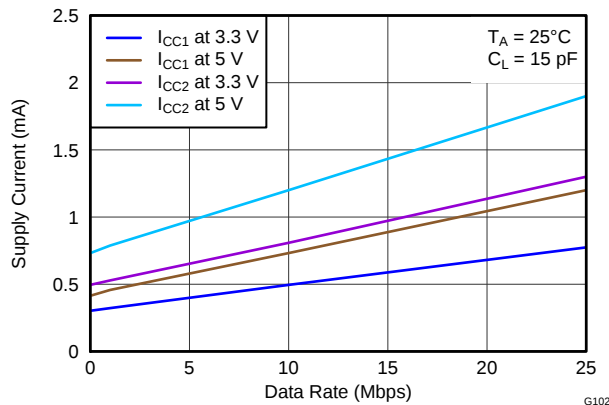
**Figure 9. ISO7631FM Supply Current For All Channels vs Data Rate**



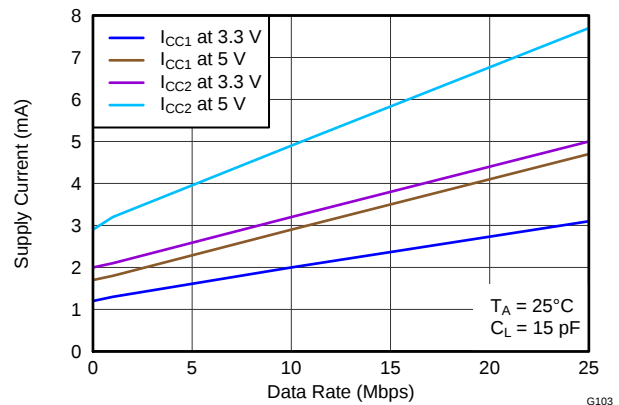
**Figure 10. ISO7631FC Supply Current Per Channel vs Data Rate**



**Figure 11. ISO7631FC Supply Current For All Channels vs Data Rate**

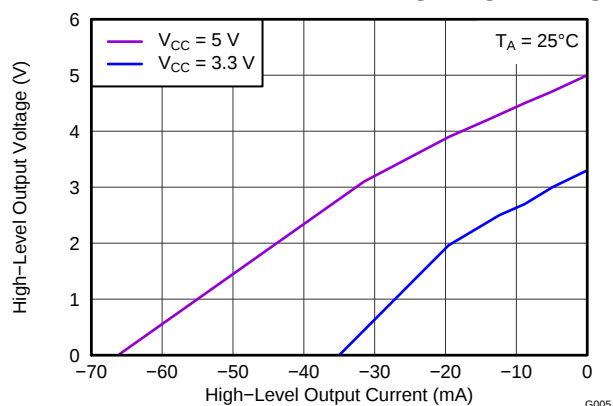


**Figure 12. ISO7641FC Supply Current Per Channel vs Data Rate**

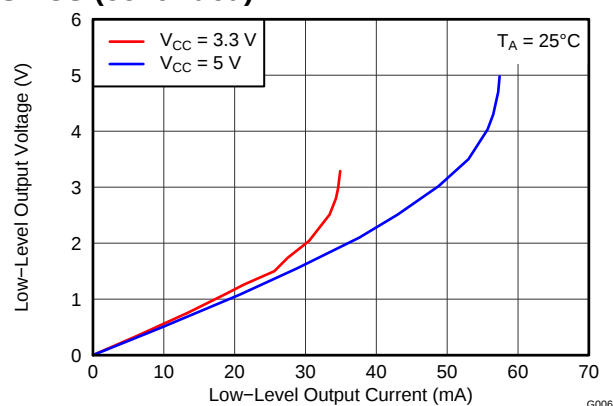


**Figure 13. ISO7641FC Supply Current For All Channels vs Data Rate**

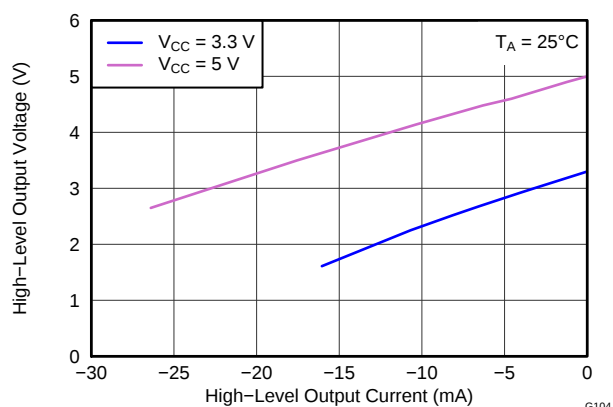
## TYPICAL CHARACTERISTICS (continued)



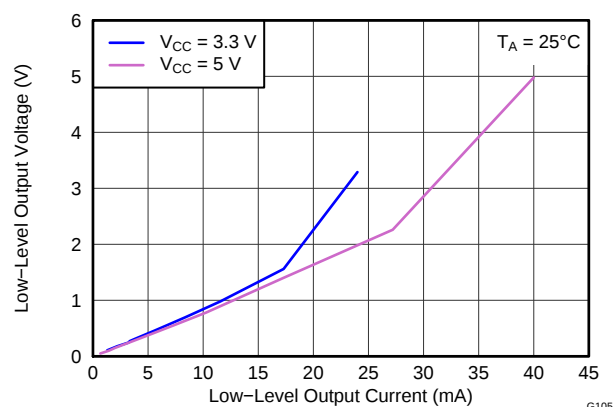
**Figure 14. M-Grade High-Level Output Voltage vs High-Level Output Current**



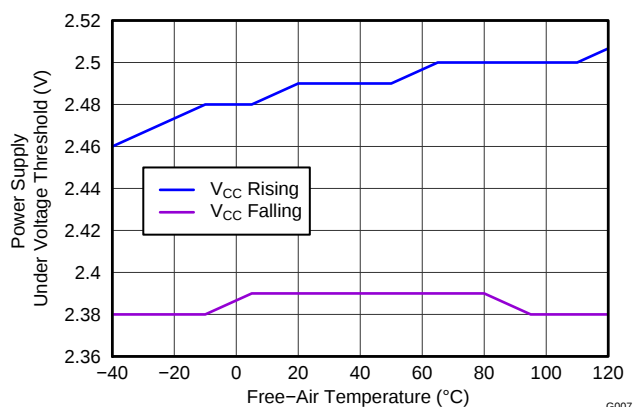
**Figure 15. M-Grade Low-Level Output Voltage vs Low-Level Output Current**



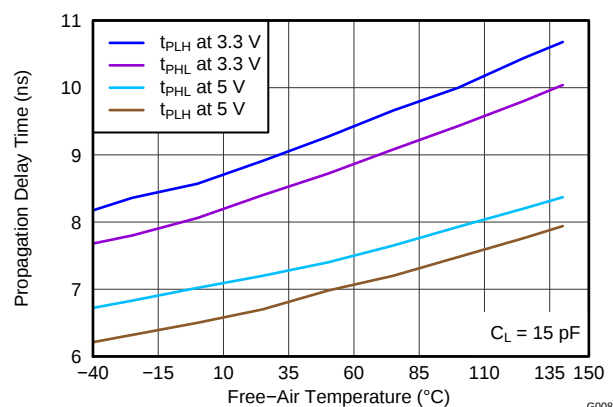
**Figure 16. C-Grade High-Level Output Voltage vs High-Level Output Current**



**Figure 17. C-Grade Low-Level Output Voltage vs Low-Level Output Current**



**Figure 18.  $V_{CC}$  Undervoltage Threshold vs Free-Air Temperature**



**Figure 19. M-Grade Propagation Delay Time vs Free-Air Temperature**

## TYPICAL CHARACTERISTICS (continued)

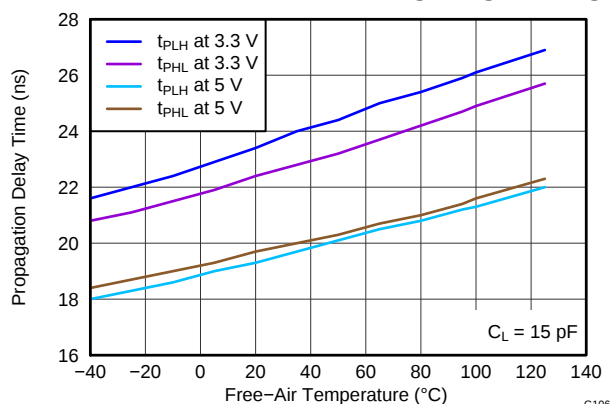


Figure 20. C-Grade Propagation Delay Time vs Free Air Temperature

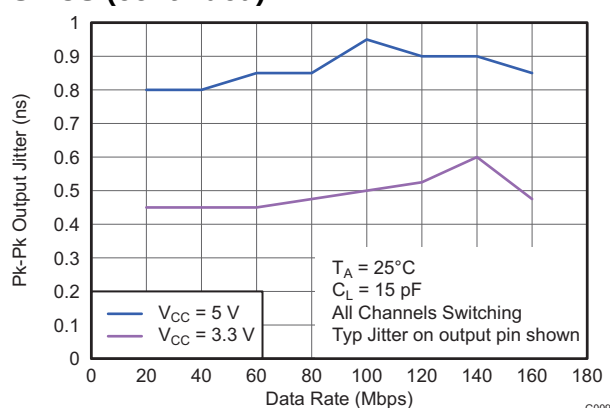


Figure 21. M-Grade Output Jitter vs Data Rate

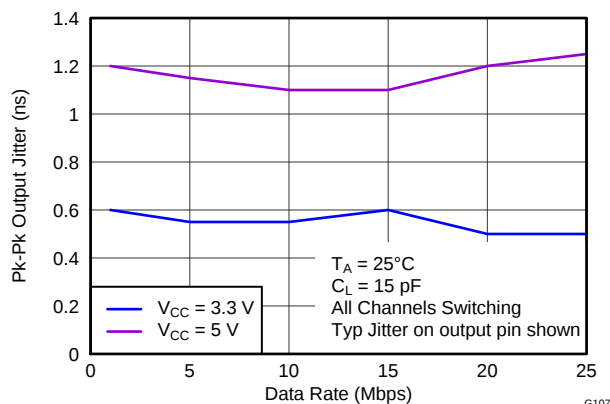


Figure 22. C-Grade Output Jitter vs Data Rate

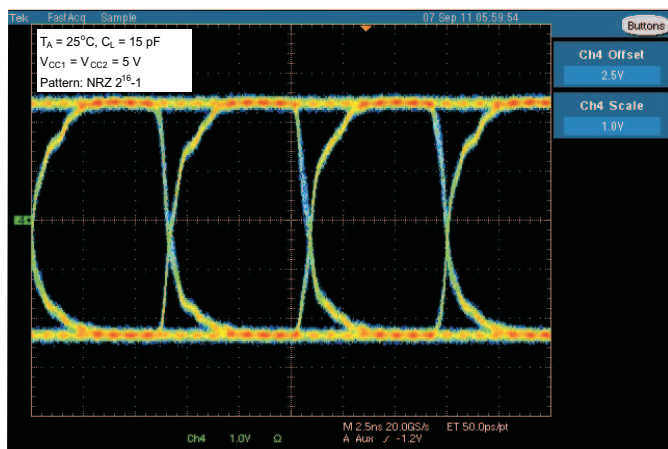


Figure 23. M-Grade Typical Eye Diagram at 150 Mbps, 5 V Operation

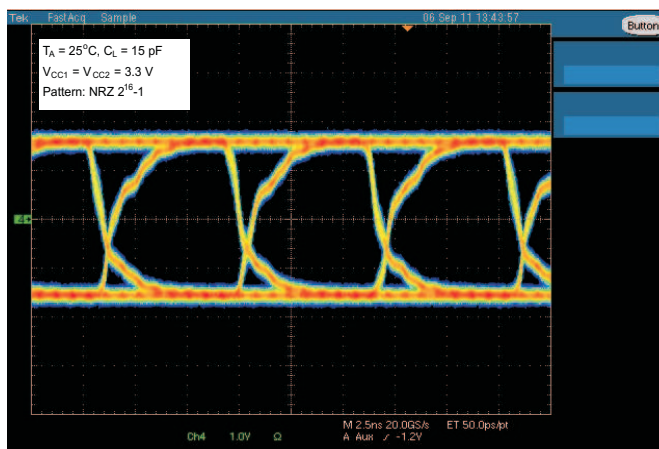


Figure 24. M-Grade Typical Eye Diagram at 150 Mbps, 3.3 V Operation

### TYPICAL CHARACTERISTICS (continued)

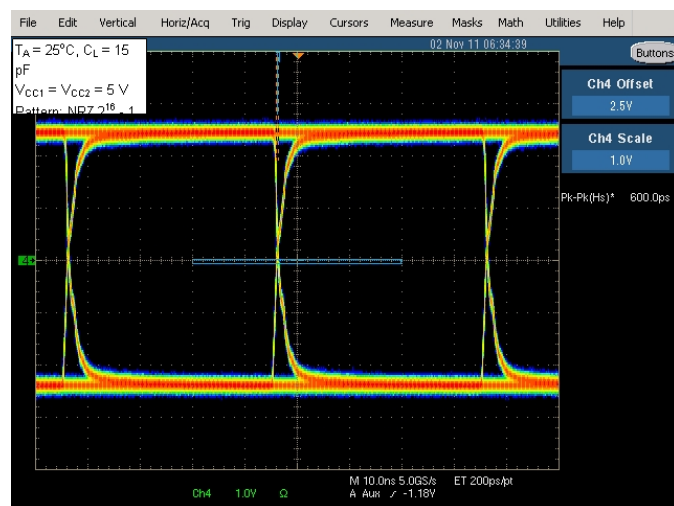


Figure 25. C-Grade Typical Eye Diagram at 25 Mbps, 5 V Operation

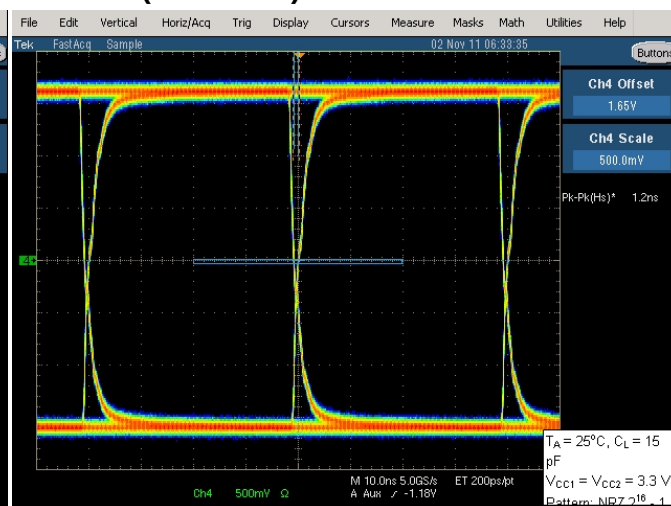


Figure 26. C-Grade Typical Eye Diagram at 25 Mbps, 3.3 V Operation

## REVISION HISTORY

### Changes from Original (September 2012) to Revision A Page

- Changed Description text From: "applications where input noise pulses of less than 10 ns duration..." To: "applications where input noise pulses of less than 6 ns duration..." ..... [1](#)
- Changed Input PU in the Function table From: Z To: 'Undetermined' ..... [2](#)
- Added note "Product Preview" to ISO7640FC in the Available Options table ..... [3](#)

### Changes from Revision A (September 2012) to Revision B Page

- Changed Safety Feature From: 4000 V<sub>PK</sub> VDE Rating for DIN EN 60747-5-2 (VDE 0884 Rev. 2) To: 4242 V<sub>PK</sub> VDE Rating for DIN EN 60747-5-2 (VDE 0884 Rev. 2) ..... [1](#)
- Changed the V<sub>IOTM</sub> SPECIFICATION From: 4000 V<sub>PEAK</sub> to 4242 V<sub>PEAK</sub> ..... [17](#)
- Changed the REGULATORY INFORMATION table: 4242 V<sub>PK</sub> To: 4000 V<sub>PK</sub> ..... [18](#)

### Changes from Revision B (April 2013) to Revision C Page

- Deleted the device image from the top of the page ..... [1](#)
- Deleted device number ISO7640FC ..... [1](#)
- Deleted Feature ISO7640FC: 1:1 mA at 10 Mbps ..... [1](#)
- Added Safety Feature: 3000 V<sub>RMS</sub> Reinforced Insulation per TUV for EN/UL/CSA 60950-1 and EN/UL/CSA 61010-1 (approved) ..... [1](#)
- Changed the Description ..... [1](#)
- Deleted the ISO7640 pin out image ..... [1](#)
- Deleted ISO7640FC from the Available Options table ..... [3](#)
- Changed The ISO7631FC Rated Isolation values in the Available Options table ..... [3](#)
- Added the TUV column to the REGULATORY INFORMATION table ..... [18](#)
- Deleted the ISO7640 circuit from the APPLICATION INFORMATION section ..... [19](#)
- Deleted ISO7640FC from the TYPICAL SUPPLY CURRENT EQUATIONS section ..... [20](#)
- Deleted Graph ISO7640FC Supply Current Per Channel vs Data Rate ..... [21](#)
- Deleted Graph ISO7640FC Supply Current For All Channels vs Data Rate ..... [21](#)

### Changes from Revision C (August 2013) to Revision D Page

- Changed the REGULATORY INFORMATION table, TUV column From: Certificate Number: U8V 13 07 77311 009 To: Certificate Number: U8V 13 09 77311 010 ..... [18](#)

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|-------------------------|-------------------------|
| ISO7631FCDW      | ACTIVE        | SOIC         | DW                 | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7631FC               | <a href="#">Samples</a> |
| ISO7631FCDWR     | ACTIVE        | SOIC         | DW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7631FC               | <a href="#">Samples</a> |
| ISO7631FMDW      | ACTIVE        | SOIC         | DW                 | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7631FM               | <a href="#">Samples</a> |
| ISO7631FMDWR     | ACTIVE        | SOIC         | DW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7631FM               | <a href="#">Samples</a> |
| ISO7641FCDW      | ACTIVE        | SOIC         | DW                 | 16   | 40             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7641FC               | <a href="#">Samples</a> |
| ISO7641FCDWR     | ACTIVE        | SOIC         | DW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR  | -40 to 125   | ISO7641FC               | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ISO7631FMDWR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| ISO7641FCDWR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS

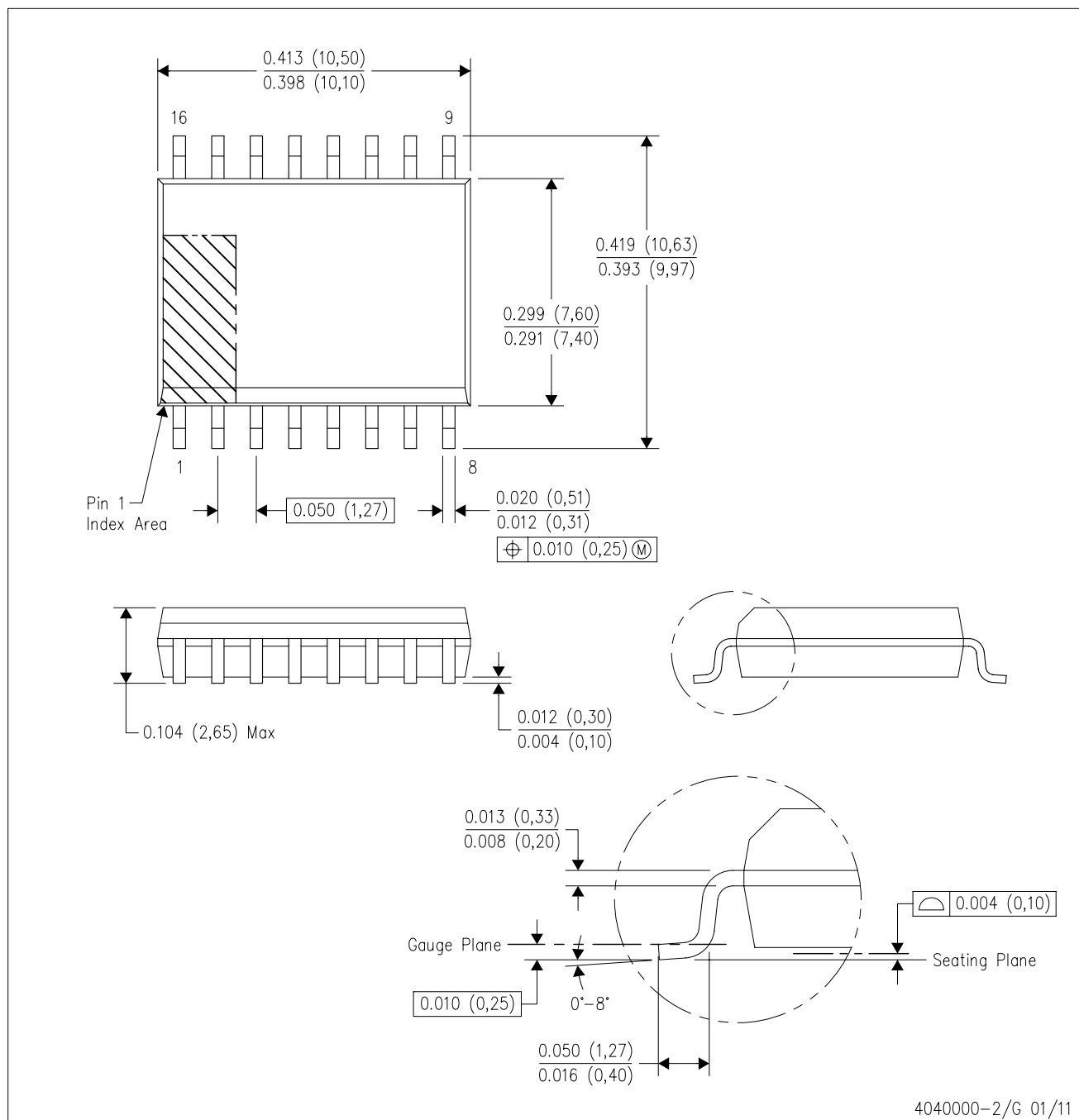


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ISO7631FMDWR | SOIC         | DW              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| ISO7641FCDWR | SOIC         | DW              | 16   | 2000 | 367.0       | 367.0      | 38.0        |

DW (R-PDSO-G16)

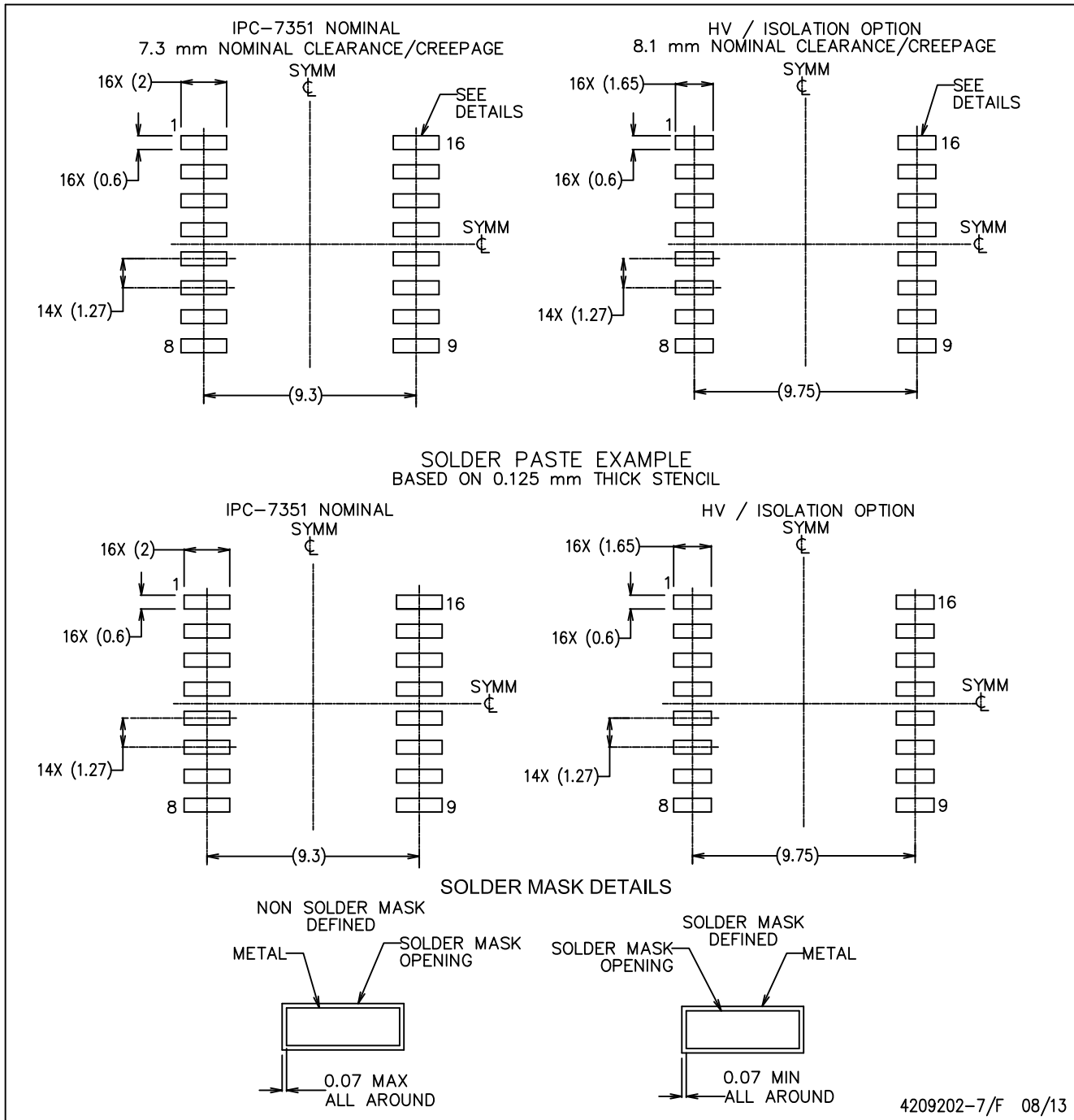
## PLASTIC SMALL OUTLINE



- NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-013 variation AA.

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4209202-7/F 08/13

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
  - E. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
  - F. Board assembly site may have different recommendations for stencil design.

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### Applications

|                               |                                                                                          |
|-------------------------------|------------------------------------------------------------------------------------------|
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